CaliPile[™]

Infrared Sensing Solutions

TPiS 1T 1086 L5.5 / 7452



Narrow Field-of-View Thermopile

The TPiS 1T 1086 L5.5 is a thermopile sensor with integrated signal processing. It provides as a member of the CaliPileTM family factory calibration data stored in the sensors EEPROM. It features a confined field of view in an isothermal TO-39 package which ensure fast adaptation to ambient temperature changes. The technology of a high sensitive thermopile combined with a smart data treatment allows for much more than the traditional temperature measurement of remote objects. Once configured via the I²C interface an interrupt output can be used to monitor fast temperature changes and an over-temperature of remote objects.

One typical application is a remote object temperature monitoring with the feature of a fast over-temperature security switch. The temperature calculation is performed on the host based on the calibration parameters but the over-temperature recognition is constantly monitored by the sensor it-self.



Product Specification

Features

- Isothermal TO-39 package
- High sensitivity thermopile with 5° field-of-view
- Integrated 50 µW low-power signal processing
- I²C interface, hardware-configurable address
- Calibration data for ambient and object temperature sensing
- Interrupt function for presence, motion, over-temperature and more

Applications

- Optimal for remote temperature measurement
- Fast remote over-temperature protection
- Mid-field human presence sensing
- Far-field human motion detection
- Passive Light-Barrier for People Counting



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1 Dimensions and Connections

Figure 1: Mechanical Dimensions (in mm) and Pin Configuration. A short description is given in table 1. The A0 output is bond internally to GND .

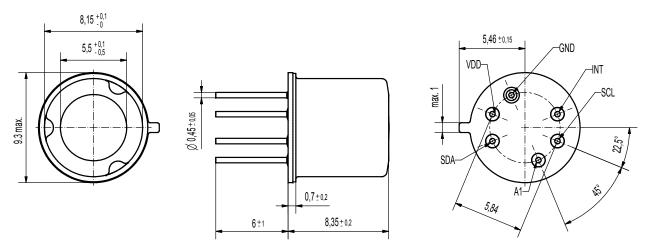


Table 1: Pin descriptions. Further explanations follow in this document.

Pin Symbol	Pin Name and short Functional Description.	Pin Type
A0,A1	Address Inputs A0, A1: Setting the last 2 bits of the slave address. Setting a	Input
	pin to GND corresponds to 0. Setting a pin to VDD corresponds to a 1. The	
	device address with both pins set to GND is 0x0C .	
VSS	Ground: The ground (GND) reference for the power supply should be set to	Power
	the host ground.	
VDD	Power Supply: The power supply for the device. Typical operating voltage is	Power
	3.3V	
SDA	Serial Data: The I ² C bidirectional data line. Open-drain driven and requires	Input/Output
	pull-up resistors to min. 1.8 V	
SCL	Serial Clock Input : The I^2C clock input for the data line. Up to 400 kHz are	Input/Output
	possible. The host must support clock stretching.	
INT	Interrupt Output: The open drain / active low Interrupt output to indicate a	Output
	detected event. Reading the chip register out resets this output.	



2 Optical Characteristics

2.1 Field of View

Figure 2 illustrates the measurement of the sensor's field of view (FOV). A hot point like heat source radiates almost parallel infrared light in a distance to the sensor. The sensor's housing is rotated around its sensor plane in all directions while recording the sensor data. A typical measurement result is shown in figure 3. The result is normalized to the peak value of the measurement. The resulting parameters are depicted in table 2.

Figure 2: Illustration of the FOV measurement setup. For details see the text.

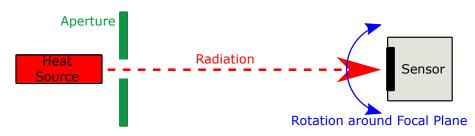


Figure 3: Typical FoV measurement result

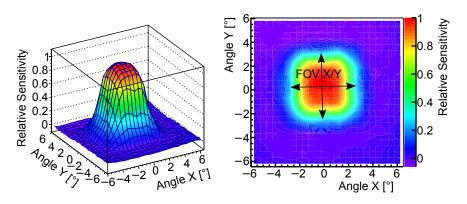


Table 2: Optical characteristics

Parameter	Symbol	Min	Тур	Мах	Unit	Remarks / Conditions
Focal length	f		5.5		mm	unpolished
Field of View X/Y	FOV X/Y		5		0	at 50 % intensity
Optical Axis		-3.7	0	3.7	0	
Distance to Spot Ratio	D:S		11.5:1			at 50 % intensity

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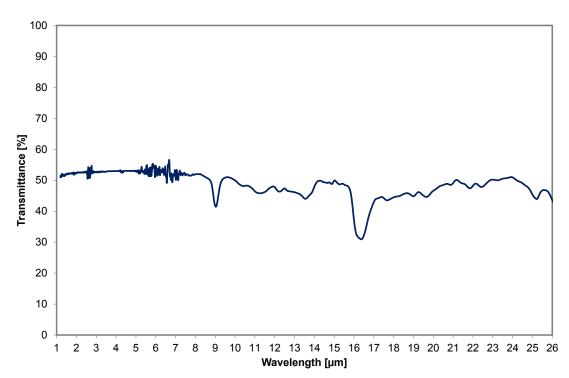
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2.2 Filter Properties

Table 3: Filter properties

Parameter	Symbol	Min	Тур	Мах	Unit	Remarks / Conditions
Average Filter Transmittance	T_A		50		%	$2 \mu m < \lambda < 15 \mu m$

Figure 4: Filter transmittance, typical curve



3 Absolute Maximum Ratings

Table 4: Maximum Ratings

Parameter	Symbol	Min	Мах	Unit	Remarks / Conditions
Operating Temperature	<i>T</i> ₀	-20	85	°C	Electrical parameters may vary from specified
					values in accordance with their temperature de-
					pendence
Storage Temperature	Ts	-40	100	°C	Avoid storage in humid environment
Supply Voltage	VDD	-0.3	3.6	٧	
Current to any pin		-100	100	mA	One pin at a time

4 Device Characteristics

Device characteristics are given at 25 °C ambient temperature unless stated otherwise.

Table 5: Power Supply

Parameter	Symbol	Min	Тур	Мах	Unit	Remarks / Conditions
Operating Voltage	VDD	2.6	3.3	3.6	۷	
Supply Current	IDD			15	μA	VDD=3.3 V

Table 6: Thermopile

Parameter	Symbol	Min	Тур	Мах	Unit	Remarks / Conditions
Sensitive Area	A		0.16		mm ²	Absorber 0.41×0.41 mm ²
Sensitivity	$\Delta counts / \Delta T$		30		counts/K	Tobj=40 °C
Noise(peak-peak)			8		counts	Tobj=40 °C
Time constant	τ		15		ms	
Power up time			250		ms	TP _{OBJ} and TP _{AMB} stable
Resolution			17		Bits	
Sensitivity		0.7	0.8	0.9	μV/count	
Offset		64 000	64 500	65 000	counts	
Max. Object Temp.	Tobj _{max}		350		°C	Full FOV, $\epsilon > 99$ %

The TPiS 1T 1086 L5.5 temperature measurement is specified for a full field-of-view coverage by a black body with more than 99% emissivity.

The calculation of a temperature has to be performed on the host system and is described in section 8. Figure 5 shows the calculated thermopile raw data $U = TP_{object}$ as a function of the ambient temperature and object temperature based on typical characteristics of TPiS 1T 1086 L5.5. The ASIC typically features a wider dynamic range as compared to the specified values in table 6 and 7. Values out of our specifications are not guaranteed.

Table 8 gives an overview on the accuracy and precision of a remote temperature measurement which can be achieved with the factory calibration. Accuracy is the mean deviation of a measured value from the true value. The precision is the statistical uncertainty (RMS) of a measurement. The calibration parameters and conditions are described in section 8. The performance in the application may vary due to physical constraints. Significantly



Parameter	Symbol	Min	Тур	Max	Unit	Remarks / Conditions
Resolution			15		Bits	
Slope			170		counts/K	–20 °C to 85 °C
Range		-20		85	°C	
Linearity		-5		5	%	–20 °C to 85 °C
Offset		11 000	13 500	17 000	counts	
Noise(peak-peak)			5		counts	

Table 7: Ambient temperature sensor (PTAT)

Figure 5: Typical temperature dependence of the raw thermopile output

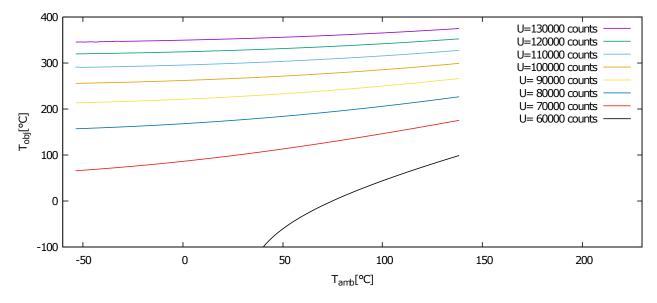


Table 8: Calibration Conditions and Temperature Measurement Specifications

Parameter	Symbol	Min	Тур	Мах	Unit	Remarks / Conditions
Distance to black body (BB)	d		26		mm	
Calib. Temp. <i>T_{BB=Obj}</i>			100		°C	
Calib. Temp. <i>T_{Amb}</i>			25		°C	
Accuracy T _{Obj}			±1		°C	@ Calib. Temp.
Precision T _{Obj}			< 0.1		°C	
Accuracy T _{Obj}			±3		°C	$40 < T_{Obj}[^{\circ}C] < 250$
Precision T _{Amb}			< 0.1		°C	
Accuracy <i>T_{Amb}</i>			±1		°C	$10 < T_{Amb}[^{\circ}C] < 80$

better performance is possible. For that the device must be re-calibrated after assembly in the end-application. Please consult our local representative for more information.



Parameter	Symbol	Min	Тур	Мах	Unit	Remarks / Conditions
Input low voltage	V _{IL}	-	-	0.6	V	
Input high voltage	V_{IH}	1.5	-	-	V	
Output low voltage	V _{OL}	0.2	-	-	V	
Output high voltage	V _{OH}	-	-	VDD	V	Open Drain
Input leakage current	$I_{ m LI}$	-1	-	1	μA	$V_I = VDD/2$
Output leakage current	I_{LO}	-	-	1	μA	$V_O = VDD$
SCL Frequency	F _{SCL}	-	-	400	kHz	
SCL high time	$T_{\rm HIGH}$	200	-	-	ns	
SCL low time	$T_{\rm LOW}$	0.2	-	90*	μs	*Slave clock stretching
refresh time		-	-	3	ms	

Table 9: Digital Interface (SCL, SDA, INT, A0, A1)

Table 10: On chip oscillator properties

Parameter	Symbol	Min	Тур	Мах	Unit	Remarks / Conditions
Frequency	Fosc	54	64	76	kHz	
Temperature Dependence		-1000		1000	ppm/K	

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5 I²C Interface Characteristics

An I²C serial interface is provided to read out the sensors data and for read and write access of configuration and status registers and to obtain calibration data from the EEPROM.

The following chapters give detailed instructions to understand and to operate the I^2C interface of the CaliPileTM. For the complete I^2C specifications (version 2.1) refer to: www.i2c-bus.org.

The SCL is a bidirectional input and output used as synchronization clock for serial communication. The SDA is a bidirectional data input and output for serial communication. The SCL and SDA outputs operate as open drain outputs only. External pull-up resistors are required. The pull-up resistor does all the work of driving the signal line high. All devices attached to the bus may only drive the SDA and SCL lines low.

The I²C interface allows connection of a master device (MD) and one or more slave devices (SD). The CaliPileTM can be operated as a SD only. The MD provides the clock signals and initiates the communication transfer by selecting a SD through a slave address (SA) and only the SD, which recognizes the SA should acknowledge (ACK), the rest of SDs should remain silent.

The general data transfer format is illustrated in figure 6.

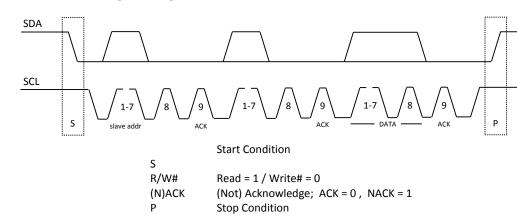
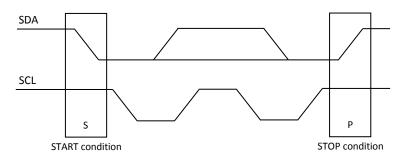


Figure 6: Illustration of voltages during I²C communication

5.1 START and STOP conditions

Figure 7: START and STOP Condition



Two unique bus situations define a message START and STOP condition which is shown in figure 7.

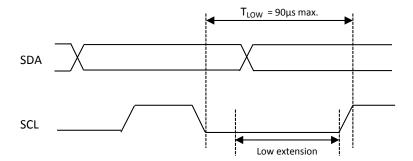
- 1. A high to low transition of the SDAT line while SCLK is high indicates a message START condition.
- A low to high transition of the SDAT line while SCLK is high defines a message STOP condition. START and STOP conditions are always generated by the bus master. After a START condition the bus is considered to be busy. The bus becomes idle again after certain time following a STOP condition or after both the SCLK and SDAT lines remain high for more than t_{HIGH:MAX}.



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5.2 Clock low extension

Figure 8: Clock low extension



The CaliPileTM may need some time to process received data or may not be ready yet to send the next byte. In this case the SD can pull the SCL clock low to extend the low period of SCL and to signal to the master that it should wait (see figure 8). Once the clock is released the master can proceed with the next byte.

5.3 Slave Address

After power up the CaliPileTM responds to the General Call Address (0x00) only. Upon receipt of a general call, it loads its slave address from EEPROM (ESA<7:0>). The slave address stored in the EEPROM consists of 7 address bits (6:0) and 1 address control bit (7). If the address control bit is set, the slave address read from the EEPROM is merged with the information from the slave address select pins A1 and A0.

ESA<7:0>	<a1:a0> state</a1:a0>	I ² C slave address
1000 1111	H:L	000 1110
1000 1100	H:L	000 1110
1000 1100	L:H	000 1101
0000 1100	L:H	000 1100
1ABC DEFG	Y:Z	ABC DEYZ
0ABC DEFG	Y:Z	ABC DEFG

Table 11: Examples for the interplay between configuration pins and the EEPROM

Some examples are given in table 11. The CaliPileTM in the standard configuration has enabled configuration pins. The standard EEPROM content is **1000 1100**. The standard slave address is therefore dec12 or 000 1100 in binary representation when the address input pins A1,A0 are both connected to ground. Pulling A0 to a high level for example will result in the slave address dec13 or 000 1101.

5.4 Protocol diagram description

In the following chapters, the communication protocol will be illustrated with diagrams. Figure 9 describes the meaning of those diagrams.

5.5 General Call

In order to re-fresh the slave address from EEPROM the MD has to send a general call (0x00) followed by the reload command (0x04). The slave may require up to $300 \,\mu s$ for copying the slave address from EEPROM information into the register.

Figure 9: Protocol diagram description

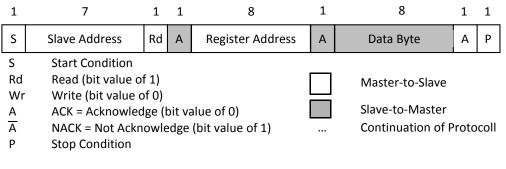
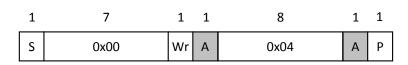


Figure 10: General call format



5.6 Reading Data from the Register

Each register can be read through the I²C bus interface. The address information following Slave address points to the register to be read. The SD may require some time to load the data into the serial interface and therefore apply "clock stretching" after reception of the address byte. Once the data is ready for transmission to the MD, clock-stretching will be released and the MD can clock out the data byte.

The address pointer on the SD will be automatically incremented to prepare for the next data byte to be fetched for transmission. The SD may apply "clock stretching" again to enforce a waiting time, before the next data byte is ready for transmission. The address pointer will wrap around to 0 once it exceeds address 63.

Reading of data can be interrupted by the MD at any time by generating a stop or a new start condition or a "not acknowledge". This is illustrated in figure 11.

1 7 8 1 7 1 1 8 1 1 1 1 S Slave Address Wr Register Address A Sr **Slave Address** Rd Data [Adr] А A Α 1 1 1 8 8 8 8 1 1 Data [Adr+1] A Data [Adr+2] Data [Adr+N-1] A Data [Adr+N] Ā Ρ A

Figure 11: Register read format

5.7 Writing Data to Register

Each register can be written to through the I²C bus interface. The address information following the Slave address specifies the location, where the next data byte is written to. The SD may require some time to write the data into the registers on chip and therefore apply "clock stretching" after reception of the data byte. Once the data is stored in the register, the slave will increment the address pointer and prepare for the next data byte to be received. The address pointer will wrap around when it exceeds 63.

Writing of data can be interrupted at any time by generating a stop or a new start condition or a "not acknowledge". This is illustrated in figure 12.

If the address points to a non-writable register, the register content remains unchanged.





5.8 Reading EEPROM

A dedicated EEPROM control register (ECR) is provided to control access mode and to allow testing of EEPROM during production. Prior to reading EEPROM memory via I2C interface the control byte needs to be set accordingly. It is of importance to configure the EEPROM control register correctly as specified to ensure correct operation. In order to enable EEPROM reading, the ECR must be set to 0x80 as depicted in figure 13.

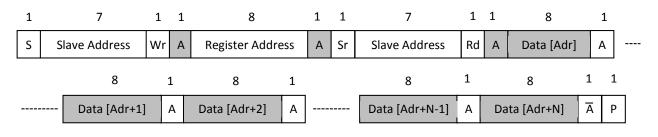
Figure 13: Configuring register for EEPROM readout



Note: Configuring the ECR for EEPROM read access causes increase of the supply current during EEPROM read operation until ECR will be set to 0x00 again.

Once the ECR has been setup correctly for read operation, the EEPROM cells can be addressed and read as drawn to figure 14.

Figure 14: Reading EEPROM



The address information following the Slave address points to the EEPROM memory location to be read. The SD may require some time to load the data into the serial interface and therefore apply "clock stretching" after reception of the address byte. Once the data is ready for transmission to the MD, clock stretching will be released and the MD can clock out the data byte.

The address pointer on the SD will be automatically incremented to prepare for the next data byte to be fetched for transmission. The SD may apply "clock stretching" again to enforce a waiting time, before the next data byte is ready for transmission. The address pointer will wrap around to 0 once it exceeds address 63.

The EEPROM control register must be configured to 0x00 after the end of the EEPROM read operation to bring the supply current back to normal (lower) level.

6 Data processing characteristics

6.1 Control and Status Registers

Table 12: Register content

Register #	Description	Size[bit]	Access
0	reserved	8	-
1-2,3[7]	TP _{object}	17	Read
3[6:0],4	TPambient	15	Read
5-7[7:4]	TP _{ObjLP1}	20	Read
7[3:0]-9	TP _{ObjLP2}	20	Read
10-11	TP _{ambLP3}	16	Read
12-14	TP _{ObjLP2} frozen	24	Read
15	TP _{presence}	8	Read
16	TP _{motion}	8	Read
17	TP _{amb shock}	8	Read
18[7:0]	Interrupt Status	8	Read(Autoclear)
19[7:0]	Chip Status	8	Read
20[3:0]	S _{LP1}	4	Write/Read
20[7:4]	S _{LP2}	4	Write/Read
21[3:0]	S _{LP3}	4	Write/Read
21[7:4]	reserved	4	-
22	TP _{presence} threshold	8	Write/Read
23	TP _{motion} threshold	8	Write/Read
24	TP _{amb shock} threshold	8	Write/Read
25[4:0]	Interrupt Mask Register	5	Write/Read
25[7:5]	reserved	3	-
26[1:0]	Cycle time for Motion differentiation	2	Write/Read
26[3:2]	SRC select for presence determination	2	Write/Read
26[4]	TP _{OT} direction	1	Write/Read
26[7:5]	reserved	3	-
27[7:0]	Timer interrupt	8	Write/Read
28,29	TP _{OT} threshold	16	Write/Read
30	reserved	8	-
31	EEPROM control	8	Write/Read
62:32	EEPROM content	248	Read
63	Slave address	8	Read

The control and status registers in table 12 give access to the variables of the integrated CaliPileTMASIC. Details on the registers are given in the following section 6.2.

While some registers contain computed values other contain parameters to control the functionality of the chip which is described in section 7.

The register control values are undefined after power-up and require an initialization procedure for a well-defined operation of the CaliPile[™].

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6.2 Control Register Details

											TΡ₀	bject											
	Register #1[7:0]Register #2[7:0]Register #3[7]																						
7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	7	-	-	-	-	-	-	-

Contains the 17 bit TP_{object} raw ADC value in digits. This represents the current signal of the thermopile sensor element.

							TPan	nbient							
	Register #3[6:0] Register #4[7:0]														
-	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0

Contains the 15 bit TP_{ambient} raw value in digits. This represents the current signal of the ambient temperature sensor (PTAT).

										٦	rP _{obj}	ectLP	1										
	Register #5[7:0]Register #6[7:0]Register #7[7:4]																						
7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	7	6	5	4	-	-	-	-

Contains the 20 bit TP_{objLP1} value in digits. This represents the low-pass-filtered value of the TP_{object} signal. To compare it with the 17 bit wide TP_{object} divide the value by $2^3 = 8$. The filter time constant for this filter stage can be set with S_{LP1} .

										٦	rP _{obj}	ectLP	2										
	Register #7[3:0] Register #8[7:0] Register #9[7:0]																						
-	-	-	-	3	2	1	0	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0

Contains the 20 bit TP_{objLP2} value in digits. This represents the low-pass-filtered value of the TP_{object} signal. To compare it with the 17 bit wide TP_{object} divide the value by $2^3 = 8$. The filter time constant for this filter stage can be set with S_{LP2} .

							TPar	nbLP3							
		Re	egister	#10[7	:0]					R	egister	#11[7	:0]		
7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0

Contains the 16 bit TP_{ambLP3} value in digits. This represents the low-pass-filtered value of the $TP_{ambient}$ signal. To compare it with the 15 bit wide $TP_{ambient}$ divide the value by $2^1 = 2$. The filter time constant for this filter stage can be set with S_{LP3} .

										TPo	bject	LP2 fr	ozen										
	Register #12[7:0] Register #13[7:0] Register #14[7:0]																						
7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0

Contains the 24 bit TP_{objLP2 frozen} value in digits. This represents the low-pass-filtered value of the TP_{object} signal when motion was detected. To compare it with the 17 bit wide TP_{object} divide the value by $2^7 = 128$. See section 7.3 for more details on the motion detection algorithm.



			TPpre	esence			
			Register	#15[7:0]			
7	6	5	4	3	2	1	0

Contains the 8 bit TP_{presence} value in digits. It is the unsigned difference between two values which combination is steered with the "source select". The sign of the value is contained in the "chip status". See section 7.2 for details.

			TPm	otion			
			Register	#16[7:0]			
7	6	5	4	3	2	1	0

Contains the 8 bit TP_{motion} value in digits. It is the unsigned difference between two consecutive values of $TP_{objectLP1}$. The sign of the value is contained in the "chip status". The interval is steered with the "cycle time". See section 7.3 for details.

			TP _{aml}	b shock			
			Register	#17[7:0]			
7	6	5	4	3	2	1	0

Contains the 8 bit $TP_{amb \ shock}$ value in digits. It is the unsigned difference between $TP_{ambient}$ and TP_{ambL1} . The sign of the value is contained in the "chip status". See section 7.4 for details.

			Interrup	ot status			
Regi	ster #18[7:5]	sign		Regi	ster #18[4:0]	flag	
7	6	5	4	3	2	1	0
TP _{presence}	TP _{motion}	TP _{amb shock}	TP _{OT}	TP presence	TP _{motion}	TP _{amb shock}	timer

Each fulfilled interrupt condition between the last readout and the current one is stored here. See also "Chip status" for the current status of the interrupt conditions. Reading this register clears the register (setting it to 0x00) and resets the physical interrupt output (release to high).

Sign is the sign bit to the corresponding unsigned 8 bit values when the interrupt condition of the corresponding interrupt calculation branches (see section 7) was fulfilled since the last readout of that register. A 0 represents a positive value and a 1 a negative value.

Flag Contains a 1 when a condition of the corresponding interrupt calculation branches was fulfilled since the last readout of that register.

Timer Contains a 1 when at least one period of the timer passed since the last readout of that register.

			Chips	status								
Register #19[7:5] sign Register #19[4:0] flag												
7	6	5	4	3	2	1	0					
TP _{presence}	TP _{motion}	TP _{amb shock}	TP _{OT}	TP _{presence}	TP _{motion}	TP _{amb shock}	timer					

Sign is the sign bit to the corresponding unsigned 8 bit values. A 0 represents a positive value and a 1 a negative value.

Flag represents the status of the corresponding interrupt calculation branches (see section 7). A 1 represents a full-filled condition for the interrupt.

Timer represents a flag toggling with the double frequency of the "timer interrupt".

This register is masked by the "Interrupt Mask" register to evaluate the condition for the physical interrupt output pin at the CaliPileTM.



	Low pass time constants S _{LP}										
Register #20[7:4] LP2					Register #20[3:0] LP1						
7	6	5	4	3	2	1	0				
	r	eserved			Register #21[3:0] LP3						
-	-	-	-	3	2	1	0				

Contains the time constants for the three low-pass filters LP1, LP2 and LP3 (see section 7). The possible settings and the corresponding values are denoted in table 25.

Table 25: Low pass settings for LP1, LP2 and LP3. Typical numbers which depend on the internal oscillator frequency as specified in table 10.

f _{cut off} [Hz]	$1/(2\pi f)$ [s]	select code [hex]	select code [bin]
6.4×10^{-1}	0.25	D	1101
3.2×10^{-1}	0.50	С	1100
1.5×10^{-1}	1	В	1011
7.9×10^{-2}	2	A	1010
3.9×10^{-2}	4	9	1001
1.9×10^{-2}	8	8	1000
9.9×10^{-3}	16	5	0101
4.9×10^{-3}	32	4	0100
2.5×10^{-3}	64	3	0011
1.2×10^{-3}	128	2	0010
6.2×10^{-4}	256	1	0001
3.1×10^{-4}	512	0	0000

TP _{presence} threshold									
	Register #22[7:0]								
7	7 6 5 4 3 2 1 0								

Contains the unsigned 8 bit threshold value for TP_{presence} in digits. Once the TP_{presence} signal exceeds this threshold the corresponding presence flag will be set in the "chip status" register. See section 7.2 for details.

	TP _{motion} threshold								
Register #23[7:0]									
7	7 6 5 4 3 2 1 0								

Contains the unsigned 8 bit threshold value for TP_{motion} in digits. Once the TP_{motion} signal exceeds this threshold the corresponding presence flag will be set in the "chip status" register. See section 7.3 for details.

	TP _{amb shock} threshold									
	Register #24[7:0]									
7	7 6 5 4 3 2 1 0									

Contains the unsigned 8 bit threshold value for $TP_{amb shock}$ in digits. Once the $TP_{amb shock}$ signal exceeds this threshold the corresponding presence flag will be set in the "chip status" register. See section 7.4 for details.



	Interrupt Mask									
	reserved		Register #25[4:0]							
-	-	-	4	3	2	1	0			
-	-	-	TP _{OT}	TP _{presence}	TP _{motion}	TP _{amb shock}	timer			

Contains the 5 bit mask value to activate the external interrupt output INT pin based on five different possible sources in the "chip status" register.

The INT pin will be activated only if the corresponding mask flag inside the interrupt mask register is set to 1 and the corresponding interrupt occurs as signaled in the "chip status" register.

Bit[4]: set to 1 activates the INT pin if the TP_{OT} flag in register "chip status" has been set

Bit[3]: set to 1 activates the INT pin if the TP_{presence} flag in register "chip status" has been set

Bit[2]: set to 1 activates the INT pin if the TP_{motion} flag in register "chip status" has been set

Bit[1]: set to 1 activates the INT pin if the TP_{amb shock} flag in register "chip status" has been set

Bit[0]: set to 1 activates the INT pin if the timer flag in register "chip status" has been set

If more than one mask bit has been set the INT pin will be activated for whatever flag in the chip status register comes first (OR condition). The INT output will remain active until the host micro-controller reads the "interrupt status" register. Interrupts are set when conditions change from inactive (0) to active (1).

Multiple									
Register #26									
reserved			TP _{OT} dir	[3:2] SRC select [1:0] cy			le time		
-	-	-	4	3	2	1	0		

TP_{OT} dir allows to select in which direction TP_{object} has to cross the TP_{OT} threshold to create an interrupt.

If 1, an interrupt is created if $\mathsf{TP}_{\mathsf{object}}$ exceeds the $\mathsf{TP}_{\mathsf{OT}}$ threshold.

If 0, an interrupt is created if TP_{object} falls below the TP_{OT} threshold.

SRC select allows to switch the signal sources to be used for the $TP_{presence}$ calculation as explained further in section 7.2. Possible values are

00	=	$TP_{object} - TP_{objLP2}$
01	=	$TP_{objLP1} - TP_{objLP2}$
10	=	$TP_{object} - TP_{objLP2\ frozen}$
11	=	TP _{objLP1} – TP _{objLP2 frozer}

Cycle time is the time between these two consecutive TP_{objLP1} points to determine TP_{motion} . This is explained further in section 7.3. Possible values are

00	=	30 ms
01	=	60 ms
10	=	120 ms
11	=	240 ms

Those are typical numbers which depend on the internal oscillator frequency as specified in table 10.



	Timer interrupt									
	Register #27[7:0]									
7 6 5 4 3 2 1 0										

Contains a timer overrun value from 30 ms up to 7.7 s in steps of 30 ms.

Timer interval = $(1 + \text{Timer interrupt}) \cdot 30 \text{ ms}$

Those are typical numbers which depend on the internal oscillator frequency as specified in table 10.

	TP _{oT} threshold														
	Register #28[7:0]									Re	egister	#29[7	:0]		
7 6 5 4 3 2 1 0							7	6	5	4	3	2	1	0	

Contains the 16 bit TP_{OT} threshold value in digits. To compare this value to the 17 bit wide TP_{object} please multiply this value by a factor of $2^1 = 2$. More details are depicted in section 7.5.

	EEPROM control register									
	Register #31[7:0]									
7	7 6 5 4 3 2 1 0									

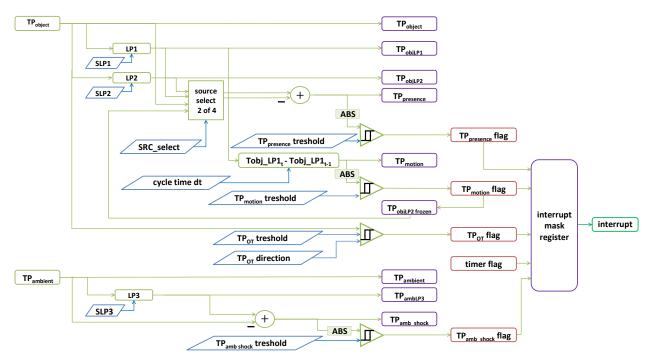
Contains the EEPROM control bits. Set it to 0x80 in order to read the EEPROM through the register. **It should be set to 0x00 in case of no access to the EEPROM.** For more details please refer to section 5.8.



7 Internal processing overview

In order to explore the complex functionalities of our CaliPile[™] products, we recommend to obtain one of our Demonstration Kits. Please ask our local representative for further advice.





The Sketch 15 gives an overview on the internal CaliPileTM data processing algorithms. The CaliPileTM contains all functions required to allow an external micro-controller to detect activity and presence. The parameters which should lead for example to a wake-up of the host micro-controller can be programmed and adapted on the fly. The algorithm is based on various filter calculations of the sensor signals TP_{object} and TP_{ambient}, their differences and time derivatives.

The CaliPileTMoffers 4 basic functions which are "presence detection", "motion detection", "ambient temperature shock detection" and "over temperature detection". Those functions can be selected by the host micro-controller as an interrupt source for wakeup. The parameters used to calculate the current state of "presence", "motion" or "shock" can be changed by the host controller through control registers. This allows the host controller to stay in sleep mode for most of the time and only be activated once the CaliPileTMdetects a change which requires intervention.

7.1 Object and Ambient Temperatures

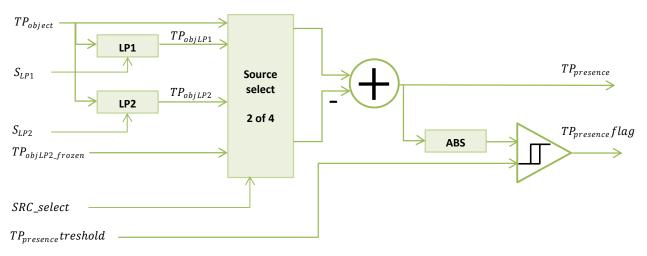
TP_{object} and TP_{ambient} are the ADC raw data from the thermopile and the internal temperature reference PTAT. To calculate the actual object temperature and ambient temperature a calculation is required on the host system based on the calibration constants from the CaliPileTM's EEPROM. Details are described in section 8. All other functionalities of the chip do not require an explicit knowledge of the actual temperatures as only relative changes are being processed. This allows a continuous operation of the CaliPileTM at a low power power consumption.

7.2 Presence Detection

Presence detection is accomplished by observing the difference between two user selectable signal paths which will be calculated from the thermopile raw signal TP_{object} (see chart 16). In order to select the optimal application



Figure 16: Presence detection algorithm chart



specific solution for presence detection, four signal path combinations are available for selection. The original TP_{object} data as provided by the thermopile, two signals, which have been processed by low pass filters LP1 and LP2 with different user programmable time constants (S_{LP1}, S_{LP2}).

$$\begin{aligned} \mathsf{TP}_{\mathsf{objLP1}}(x) &= \mathsf{TP}_{\mathsf{object}}(x) \cdot S_{\mathsf{LP1}} + \mathsf{TP}_{\mathsf{objLP1}}(x-1) \cdot (1-S_{\mathsf{LP1}}) \\ \mathsf{TP}_{\mathsf{objLP2}}(x) &= \mathsf{TP}_{\mathsf{object}}(x) \cdot S_{\mathsf{LP2}} + \mathsf{TP}_{\mathsf{objLP2}}(x-1) \cdot (1-S_{\mathsf{LP2}}) \end{aligned}$$

The signal $TP_{ObjLP2 frozen}$ which is the TP_{ObjLP2} output, that was saved at the moment the last motion event was detected.

Thus various calculations for presence detection are possible and can be adapted to the actual conditions e.g.:

The difference of those two selected signals paths is then compared with a programmable threshold TP_{presence} threshold. The TP_{presence} flag is set once the difference of the two signals exceeds the threshold. **Recommended settings to start the evaluation with are:**

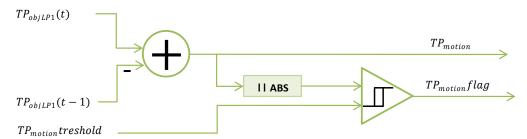
variable	value	meaning
S _{LP1}	bin 1011	1 s
S _{LP2}	bin 1000	8 s
SRC select	bin 01	TP _{objLP1} – TP _{objLP2}
TP _{presence} threshold	dec 50	±50 counts
Interrupt Mask	bin 0000 1000	TP _{presence}

Other register values are not important for that parameter set.



7.3 Motion detection

Figure 17: Motion detection algorithm chart



Motion detection is accomplished by observing the difference between two consecutive samples of TP_{objLP1} with a programmable time interval dt. This is comparable to the 1st derivative of TP_{objLP1} .

$$\mathsf{TP}_{\mathsf{motion}} = \frac{d\mathsf{TP}_{\mathsf{objLP1}}}{dt}$$

The difference of the two signals paths is then compared with a programmable threshold $TP_{motion threshold}$. The TP_{motion} flag is set once the difference exceeds the threshold. This is illustrated in figure 17.

At the moment the TP_{motion} flag is set, the current value of TP_{objLP2} will be saved as TP_{objLP2} frozen for further use in the presence detection algorithm.

Recommended settings to start the evaluation with are:

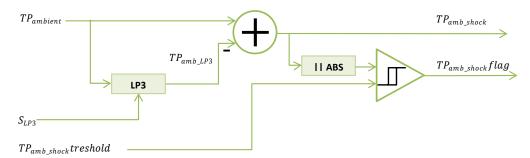
variable	value	meaning
S _{LP1}	bin 1100	0.5 s
cycle time	bin 10	120 ms
TP _{motion} threshold	dec 10	±10 counts
Interrupt Mask	bin 0000 0100	TP _{motion}

Other register values are not important for that parameter set.

It should be noticed that motion detection requires a fast change in the signal. It is thus suitable for small fieldof-views in case of large distances to the sensor. To reduce the field-of-view of a sensor apply lens or aperture optics.

7.4 Ambient temperature shock detection

Figure 18: Ambient Temperature shock detection algorithm chart



As shown in figure 18 the ambient temperature shock detection is accomplished by observing the difference between $TP_{ambient}$ and the low pass filtered $TP_{amb LP3}$. The difference of the two signals will then compared with a



programmable threshold TP_{amb shock} threshold. The TP_{amb shock} flag is set once the difference exceeds the threshold to indicate a sudden change in the ambient temperature.

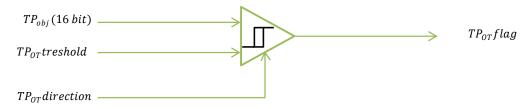
Recommended settings to start the evaluation with are:

variable	value	meaning
S _{LP3}	bin 1010	2 s
TP _{amb shock} threshold	dec 10	±10 counts
Interrupt Mask	bin 0000 0010	TP _{amb shock}

Other register values are not important for that parameter set.

7.5 Object temperature over or under limit detection

Figure 19: Object temperature over or under limit detection algorithm chart



The TP_{object} raw data is compared against the value specified in the object temperature threshold TP_{OT} threshold. This is illustrated in figure 19. An event is generated whenever the object temperature crosses the threshold. The user can select by the use of the corresponding control registers, the condition which should lead to an interrupt: Exceeding the limit or falling below the limit.

The interrupt is cleared when the micro-controller reads the interrupt status register. A new interrupt can only be generated with a new event (object temperature crosses the threshold).

To ensure correct system start up, the over temperature flag is set and the interrupt output is switched active after the device has been powered up. This feature is achieved with an on chip power on reset.

Note that TP_{object} is the thermopile raw value which does not necessarily correspond to one fixed object temperature. This is specially the case when the ambient temperature changes. See also figure 5 for an illustration. To determine TP_{object} and/or a threshold for a given object temperature, refer to section 8.

7.6 Hysteresis

The calculations for TP_{presence} TP_{motion} and TP_{amb shock} apply a hysteresis of 12.5 % of the actual threshold value. The minimum hysteresis value is fixed to 5 counts. That means that the actual value must fall below the threshold by 12.5 % of the threshold or at least by 5 counts in order to change the corresponding "chip status" bit to 0. For the object temperature over/under limit detection TP_{OT} threshold there is a fixed hysteresis of 64 counts built into the threshold comparator. This is large enough to suppress the noise on the signals and to prevent false or frequent triggering of the corresponding flags if the signal is close to the threshold. It may lead to confusion when for example extremely small amplitudes are being evaluated which in turn require small thresholds.

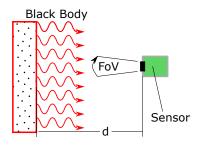


8 Temperature Measurement

8.1 Calibration Conditions

The thermopile output is related to the net IR-radiation. The net IR-radiation can be correlated with the object temperature for a specific fixed set-up. The set-up valid for the factory calibration constants is shown in sketch 20.

Figure 20: Measurement conditions



A fluid heated plane black body with an outer dimension covering at least 4 times the sensors field-of-view (FoV) and an emissivity of better than 95% has a surface temperature T_{obj} of 100°C. The surface temperature uniformity is better than 0.2°C. The ambient temperature T_{amb} is at 25°C ± 3°C. The TPiS 1T 1086 L5.5 sensor is mounted at a distance d of 26 mm to the black body.

Conditions other than described in this document generally require a customized object calibration. Otherwise sensor performance may be different than specified here. Please contact our local representative for more details.

8.2 EEPROM content

Register#	EEPROM#	Name	Description	Content Example
32	0	PROTOCOL	EEPROM Protocol number	3
33,34	1,2	CHKSUM	Checksum of all EEPROM contents excluding	-
			cell 1,2	
35 40	38	reserved	reserved	-
41	9	LOOKUP#	Identifier for look-up-table	2
42,43	10,11	PTAT25	Tamb output in digits at 25 °C	13 500
44,45	12,13	М	PTAT slope [digits/K]×100	17 200
46,47	14,15	U ₀	TP offset, <i>U</i> ₀ – 32768	31 732
48,49	16,17	U _{OUT1}	TP output for T_{OBJ1} at 25 °C, $U_{out}/2$	33 850
50	18	T _{OBJ1}	T_{OBJ} value in °C for U_{OUT1}	100
51 62	19 30	reserved	reserved	-
63	31	SLAVE ADD	I ² C slave address with external addressing bit	140

Table 37: EEPROM content



8.3 **EEPROM Details**

	PROTOCOL												
	Register #32[7:0]												
7	7 6 5 4 3 2 1 0												

Contains the 8 bit EEPROM Protocol number as an unique identifier. The default protocol number is 3.

	CHSUM														
		R	egister	[.] #33[7	:0]					Re	egister	[.] #34[7	:0]		
7	7 6 5 4 3 2 1 0									5	4	3	2	1	0

Contains the 16 bit checksum in digits. The checksum is computed as a sum of all EEPROM cells excluding the checksum cells themselves (cell# 1,2).

	LOOKUP#											
	Register #41[7:0]											
7	7 6 5 4 3 2 1 0											

Contains the 8 bit look-up-table identifier which defines the functional behaviour of that specific device. The default value for that product type is 2. For details please refer to section 8.5.

	PTAT25														
		Re	egister	#42[6	:0]					Re	egister	#43[7	:0]		
- 6 5 4 3 2 1 0								7	6	5	4	3	2	1	0

Contains the 15 bit TP_{ambient} value of the internal PTAT in digits at an ambient temperature of 25 °C. The first bit is unused and always 0. A typical value is 13 500 counts. For details please refer to section 8.4.

	М														
Register #44[7:0]										Re	egister	[.] #45[7	:0]		
7 6 5 4 3 2 1 0								7	6	5	4	3	2	1	0

Contains the 16 bit slope value of the internal PTAT in digits per Kelvin scaled by a factor of 100.

$$M = \text{RegVal}/100$$

A typical slope is 172 counts/K. For details please refer to section 8.4.

	U ₀														
Register #46[7:0]										Re	egister	#47[7	:0]		
7 6 5 4 3 2 1 0								7	6	5	4	3	2	1	0

Contains the 16 bit $\ensuremath{\text{TP}_{object}}$ offset value of the thermopile subtracted by 32 768 counts.

 $U_0 = \text{RegVal} + 32768$

A typical offset is 64 500 counts. For details please refer to section 8.5.



	U _{OUT1}														
Register #48[7:0] Register #49[7:0]											:0]				
7 6 5 4 3 2 1 0									6	5	4	3	2	1	0

Contains the 16 bit TP_{object} value of the thermopile divided by a factor of 2 when facing a black body with a temperature of T_{OBJ1} at an ambient temperature of 25 °C.

$$U_{\text{OUT1}} = \text{RegVal} \cdot 2$$

A typical value is 67 700 counts. For details please refer to section 8.5.

	Т _{овј1}											
	Register #50[7:0]											
7 6 5 4 3 2 1 0												

Contains the 8 bit value in °C for the black body giving the response of U_{OUT1} . A typical value is 100 °C. For details please refer to section 8.5.

SLAVE ADD Register #63							
7	6	5	4	3	2	1	0
ADD PIN	I ² C base address						

Contains the 7 bit I^2C base address which is completed by the A0,A1 external pin settings when ADD PIN is set to 1. For details please refer to section 5.3.



8.4 Calculation of the Ambient Temprature

For a correct object temperature calculation the ambient temperature must be known. The temperature should be calculated in Kelvin and not $^{\circ}$ C. To calculate the ambient temperature out of TP_{ambient} the following formula can be applied.

$$T_{\text{amb}}[K] = (25 + 273.15) + (TP_{\text{ambient}} - PTAT25) \cdot (1/M)$$

using the calibration constants PTAT25 and M from the EEPROM.

The inverse to calculate an expected PTAT value for a given temperature T_{amb} is given by

 $TP_{ambient}[counts] = [T_{amb} - (25 + 273.15)] \cdot M + PTAT25$

8.5 Calculation of the Object Temperature

The thermopile output signal TP_{object} is not only depending on the objects temperature but also on the ambient temperature T_{amb} as demonstrated in figure 5. To obtain the object temperature T_{obj} calculate

$$T_{\text{object}}[K] = F\left[\frac{\text{TP}_{\text{object}} - U_0}{k} + f(T_{\text{amb}})\right]$$

where T_{amb} is obtained as discussed in section 8.4. k is a scaling/calibration factor given by

$$k = \frac{U_{\text{out1}} - U_0}{f(T_{\text{obj1}}[^\circ\text{C}] + 273.15) - f(25 + 273.15)}$$

and contains the emissivity ϵ of the object as well as the field-of-view coverage factor Θ . Since our devices are calibrated for a full FOV coverage ($\Theta = 1$) and an object emissivity of nearly $\epsilon = 1$, this factor has to be scaled properly to adjust for a different object property in the application by

$$k \longmapsto k \cdot (\boldsymbol{\epsilon} \cdot \boldsymbol{\Theta})$$

with e and Θ in the range of 0 to 1. f(x) is in the simplest case an exponential with the exponent defined by the identifier LOOKUP#.

$$f(x) = x^{4.2}$$
 if LOOKUP# = 2

It's reverse function F(x) is then

$$F(x) = \sqrt[42]{x}$$
 if LOOKUP# = 2

Moreover U_0 , U_{out1} and T_{obj1} are calibration parameters from the EEPROM. To predict a thermopile output based on the object temperature T_{obj} and ambient temperature T_{amb} calculate

$$\mathsf{TP}_{\mathsf{object}}[\mathsf{counts}] = k \cdot \left[f(T_{\mathsf{obj}}[^{\circ}\mathsf{C}] + 273.15) - f(T_{\mathsf{amb}}[^{\circ}\mathsf{C}] + 273.15) \right] + U_0$$

Since exponents and roots are heavy operations to be performed on a micro-controller based system, we recommend to implement f(x) as a lookup table. An implementation in Object-C language can be provided upon request. You may contact our local representative for more details.

9 Integration instructions and recommendations

9.1 PCB layout and Wiring Patterns

In general, the wiring must be chosen such that crosstalk and interference to/from the bus lines is minimized. The bus lines are most susceptible to crosstalk and interference at the high levels because of the relatively high impedance of the pull-up devices.

If the length of the bus line on a PCB or ribbon cable exceeds 5 cm and includes the VDD and VSS lines, the wiring pattern must be:

SDA - VDD - VSS - SCL

and only if the VSS line is included we recommend

SDA - VSS - SCL

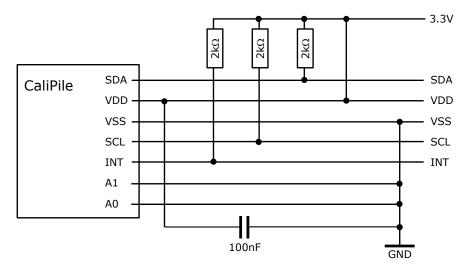
as a pattern. THese wiring patterns also result in identical capacitive loads for the SDA and SCL lines. The VSS and VDD lines can be omitted if a PCB with a VSS and/or VDD layer is used.

If the bus lines are twisted-pairs, each bus line must be twisted with a VSS return. Alternatively, the SCL line can be twisted with a VSS return, and the SDA line twisted with a VDD return. In the latter case, capacitors must be used to decouple the VDD line to the VSS line at both ends of the twisted pairs.

If the bus lines are shielded (shield connected to VSS), interference will be minimized. However, the shielded cable must have low capacitive coupling between the SDA and SCL lines to minimize crosstalk.

The PCB design requires, an optimization procedure to achieve the best signal quality. As a starting point sketch 21 is given. Values for pull-up resistors must be replaced by matching ones, fitting the capacitive load of lines. In case of strong EMI observations additional RC-filtering components might be required at the sensor inputs and outputs which is not depicted in the sketch.

Figure 21: Exemplary wiring layout



9.2 Position

In order to obtain the highest possible performance it is possible to operate the sensor without a (protecting) front window. To measure a temperature based on Excelitas calibration constants no window between the sensor and the object must be used. Excelitas calibration values are only valid when the bare sensor is exposed to the object. As the device is equipped with a highly sensitive infra-red detector. It is sensitive any source of heat, direct or indirect. For a proper temperature measurement the device must be at the same temperature as the ambient. Sudden temperature changes will directly affect the behaviour of the internal calculations such as motion, presence and over-/under-temperature recognition. While slow variations of the sensor and ambient temperature



may be tolerated for a proper function of the motion and presence features, a drift in the ambient temperature needs to be compensated for the over-/under-temperature feature as mentioned in the corresponding section. This device is equipped with a highly sensitive ADC and integrated circuits. Common rules of electronics integration apply. We recommend to place strong EMI sources far apart and/or to shield those.

9.3 Soldering

For the soldering of the detectors within PCBs, the typically applied and recommended process is wave soldering. The recommended soldering temperature shall not exceed 300 °C with a maximum exposure time of 5 s. Other soldering processes are also possible when maintaining similar temperature profiles. Temperatures higher than recommended may affect its performance. Any soldering process should be qualified to avoid damage to the sensor.

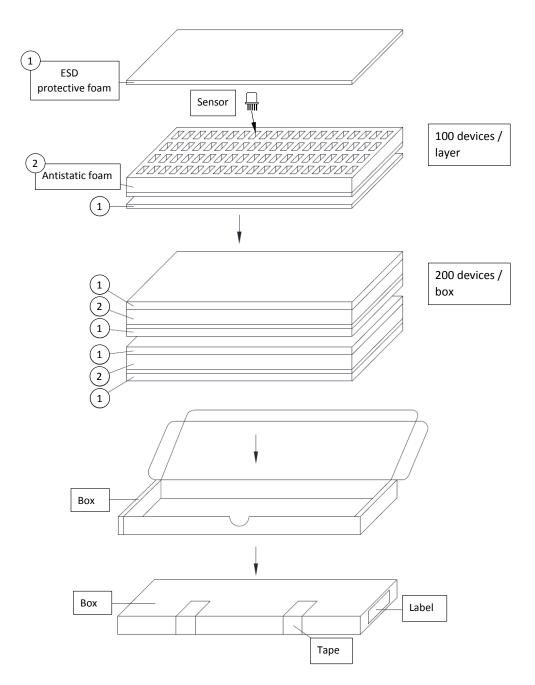


10 Packaging Specification

10.1 General Information

The Excelitas Technologies sponge packaging system protects the product from mechanical and electrical damage and is designed for manual unloading. The system consists of sponges which are protected against ESD. Up to 100 parts are filled into one box. Information labels, ESD labels and bar-code Labels (optional) are placed on the box. Figure 22 shows the basic outline.

Figure 22: Sponge packaging system for manual unload.





11 Statements

Patents For several features of the CaliPileTM patents have been granted.

Quality Excelitas Technologies is a ISO 9001:2015 certified manufacturer with established SPC and TQM. Excelitas Technologies is certified for it's Environmental Management System according to ISO 14001:2015 and for the Occupational Safety and Health Management System according to ISO 45001:2018. All devices employing PCB assemblies are manufactured according IPC-A-610 class 2 guidelines. The infra-red detection product line is certified for ANSI/ESD S.20.20:2014.

Moisture Sensitivity Level Moisture sensitivity level classification does not apply to TO-can products. Storage at high humidities should be avoided.

Electrostatic Discharge Performance All pins pass the electrostatic discharge sensitivity (ESD) test level 1 (± 2 kV) according to IEC 61000-4-2. Please make sure not to confuse this norm with other norms such as ANSI/ESDA-JEDEC JS-001-2010 (Human Body Model), ESD DS5.3.1 (Charge Device Model) or ESD STM5.2 (Machine Model).

RoHS This sensor is a lead-free component and complies with the current RoHS regulations, especially with existing road-maps of lead-free soldering.

Liability Policy The contents of this document are subject to change. The details of this document are valid by the specified revision date. Excelitas reserves the right to change at any time total or part of the content of this specifications without individual notification. Customers should consult with Excelitas Technologies' representatives to ensure updated specifications before ordering.

Customers considering the use of Excelitas Technologies devices in applications where failure may cause personal injury or property damage, or where extremely high levels of reliability are demanded, are requested to discuss their concerns with Excelitas Technologies representatives before such use.

The Company's responsibility for damages will be limited to the repair or replacement of defective product. As with any semiconductor device, thermopile sensors or modules have a certain inherent rate of failure. To protect against injury, damage or loss from such failures, customers are advised to incorporate appropriate safety design measures into their product.

